1-178317-3 ACTIVE

Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-178317-3

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.81 mm [. 15 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

Dynamic 3000 Series

View on TE.com >

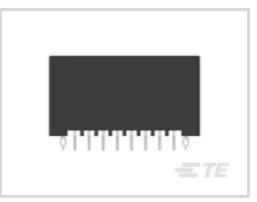


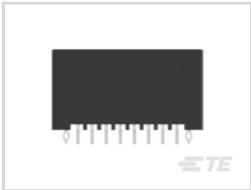
Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated











PCB Connector Assembly Type: PCB Mount Header

Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Centerline (Pitch): 3.81 mm [.15 in]

All Header Assembly: Wire-to-Board, 15A, gold or tin plated (120)

Features

Product Type Features

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PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	8
Number of Rows	1
PCB Mount Orientation	Vertical
Body Features	
Primary Product Color	Black



Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	15 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
Housing Features	
Housing Material	Polyester GF
Centerline (Pitch)	3.81 mm[.15 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241)

Box, Tube



Does not contain REACH SVHC

Wave solder capable to 265°C

Halogen Content	Not Low Halogen - contains Br or Cl > 900
	ppm.

Product Compliance Disclaimer

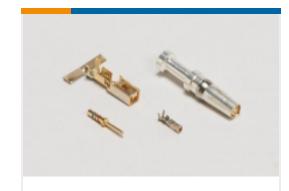
Solder Process Capability

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Dynamic 3000 Series



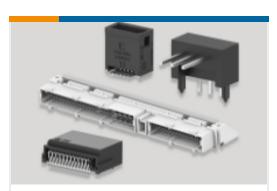
Connector Contacts(94)



Connector Hardware(8)



Insertion & Extraction Tools(2)



PCB Headers & Receptacles(283)

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series





PCB Terminal Blocks(37)



Standard Rectangular Connectors(2)



Wire-to-Board Connector Assemblies & Housings(152)

Customers Also Bought





TE Part #1-1318114-3 DYNAMIC D-2100 TAB HSG 6P P/M



Header Assembly: Wire-to-Board, 15A, gold or tin plated









Documents

Product Drawings

DYNAMIC S/ROW HDR 8P V ASSY

Japanese

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_1-178317-3_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_1-178317-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_1-178317-3_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series



Product Specifications

Product Specification

English

Agency Approvals

TUV Certificate

English